

Title (en)  
Electrical connector for circuit board

Title (de)  
Elektrischer Steckverbinder für Leiterplatte

Title (fr)  
Connecteur électrique pour carte de circuit imprimé

Publication  
**EP 1109259 B1 20040929 (DE)**

Application  
**EP 00126378 A 20001202**

Priority  
DE 19960856 A 19991216

Abstract (en)  
[origin: EP1109259A2] A contact structure comprises contactors made of conductive material, each comprising an intermediate portion inserted in a through hole of a substrate. A spring portion is provided and exerts a resilient contact force when the contactor is pressed against the contact target. A contact structure comprises a substrate (20) having through holes running through upper and lower surfaces; and contactors (30) made of conductive material and are mounted on the substrate. Each contactor comprises an intermediate portion inserted in the through hole. A contact portion is connected to the intermediate portion and positioned at one end of the contactor. A base portion is provided at the other end of the contactor. A spring portion is provided between the base portion and the intermediate portion. It has a cantilever shape and is inclined to the substrate. It exerts a resilient contact force when the contactor is pressed against the contact target (300). Independent claims are also included for the following: (A) the production of a contact structure comprising forming a sacrificial layer on a silicon substrate; forming a photoresist layer on the sacrificial layer; aligning a photomask over the photoresist layer and exposing the photoresist layer with ultraviolet light; developing image pattern of the contactors on the photoresist layer; forming the contactors on the photoresist layer; stripping off the photoresist layer; removing the sacrificial layer to separate the contactors from the silicon substrate; and mounting the contactors on a substrate, so that at least one end of the contactors functions as a contact pad (320); and (B) a probe contact comprising a contact substrate having contactors, a probe card for mounting the contact substrate, and a pin block having contact pins interfacing between the probe card and a semiconductor test system.

IPC 1-7  
**H01R 12/20; H01R 12/22; H01R 13/24; H01R 13/193; H01R 13/646**

IPC 8 full level  
**B29C 33/30 (2006.01); H01R 12/55 (2011.01); H01R 12/71 (2011.01); H01R 13/193 (2006.01); H01R 13/24 (2006.01); H01R 43/02 (2006.01); H05K 1/00 (2006.01)**

CPC (source: EP US)  
**H01R 12/724 (2013.01 - EP US); H01R 43/0256 (2013.01 - EP US); H01R 43/0263 (2013.01 - EP US)**

Cited by  
DE102017125811A1; KR20110093838A; WO2010060511A1; US8317523B2; WO2019086066A1; DE202018006398U1

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DOCDB simple family (application)  
**EP 00126378 A 20001202; CA 2328327 A 20001214; CN 00135694 A 20001215; DE 19960856 A 19991216; DE 50007981 T 20001202; US 73797800 A 20001215**